General Description

Applications

The MAX1806 low-dropout linear regulator operates from a +2.25V to +5.5V supply and delivers a guaranteed 500mA load current with low 175mV dropout. The high-accuracy (\pm 1%) output voltage is preset at an internally trimmed voltage (see *Selector Guide*) or can be adjusted from +0.8V to +4.5V with an external resistive-divider.

An internal PMOS pass transistor allows low 210µA supply current, making this device ideal for portable equipment such as personal digital assistants (PDAs), cellular phones, cordless phones, and other equipment, including base stations and docking stations.

Other features include an active-low, power-OK output that indicates when the output is out of regulation, a 0.02 μ A shutdown mode, short-circuit protection, and thermal shutdown protection. The MAX1806 comes in a miniature 1.3W, 8-pin power- μ MAX package with a metal pad on the underside of the package.

Notebook Computers Cellular and Cordless Telephones PDAs Palmtop Computers Base Stations USB Hubs Docking Stations

Vin νουτ +2.25V TO +5.5V 0.8V TO 4.5V IN OUT COUT 10µF MIXIM R_{POK} MAX1806 $100k\Omega$ TO SHDN POK uС OFF GND SFT

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

Typical Operating Circuit

Preset at 0.8V, 1.5V, 1.8V, 2.5V, or 3.3V

Features

Power-OK Output
Low 210µA Ground Current

Output Down to 0.8V

- ♦ 0.02µA Shutdown Current
- Thermal Overload Protection

Guaranteed 500mA Output Current

Adjustable from 0.8V to 4.5V

Low 175mV Dropout at 500mA

±1% Output Voltage Accuracy

- Output Current Limit
- ♦ Tiny 1.3W, 8-Pin Power-µMAX Package

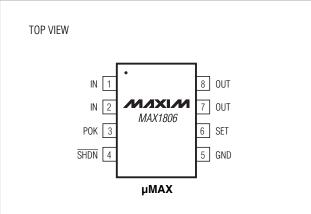
Ordering Information

PART	TEMP. RANGE	PIN-PACKAGE
MAX1806EUA	-40°C to +85°C	8 Power-µMAX

Selector Guide

PART AND SUFFIX	Vout (V)	TOP MARK
MAX1806EUA33	3.3	AAAG
MAX1806EUA25	2.5	AAAH
MAX1806EUA18	1.8	AAAI
MAX1806EUA15	1.5	AAAJ
MAX1806EUA08	0.8	AAAK

Pin Configuration



Maxim Integrated Products 1

ABSOLUTE MAXIMUM RATINGS

IN, SHDN, POK, SET to GND	-0.3V to +6V
OUT to GND	0.3V to (V _{IN} + 0.3V)
Output Short-Circuit Duration	Continuous
Continuous Power Dissipation ($T_A = +$	70°C)
8-Pin Power-µMAX (derate 17mW/°	C above +70°C)1.3W

Operating Temperature	40°C to +85°C
Junction Temperature	
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{IN} = V_{OUT(SETPOINT)} + 500mV \text{ or } V_{IN} = +2.25V \text{ whichever is greater, SET} = GND, \overline{SHDN} = IN, T_A = 0°C to +85°C, unless otherwise noted. Typical values are at T_A = +25°C.)$

PARAMETER	SYMBOL	CC	ONDITIONS	MIN	ТҮР	MAX	UNITS
Input Voltage	VIN			2.25		5.5	V
Input Undervoltage Lockout	VUVLO	Rising, 40mV hyste	eresis	1.85	2.0	2.15	V
		T _A = +85°C, I _{OUT} :	$T_A = +85^{\circ}C, I_{OUT} = 100mA$			+1	
Output Voltage Accuracy		$T_A = +85^{\circ}C, I_{OUT} =$	= 1mA to 500mA	-1.5		+1.5	0/
(Preset Mode)	Vout		$T_A = 0^{\circ}C \text{ to } +85^{\circ}C, \text{ I}_{OUT} = 1\text{mA to } 500\text{mA},$ $V_{IN} > V_{OUT} + 0.5\text{V}$			+3	%
Adjustable Output Voltage				0.8		4.5	V
		$T_A = +85^{\circ}C, I_{OUT} =$	= 100mA	790		810	
SET Voltage Threshold		T _A = +85°C, I _{OUT} :	= 1mA to 500mA	786		814	
(Adjustable Mode)	VSET	$T_A = 0^{\circ}C \text{ to } +85^{\circ}C$ $V_{IN} > V_{OUT} + 0.5V$, $I_{OUT} = 1$ mA to 500mA,	774	800	826	mV
Maximum Output Current	IOUT			500			mA _{RMS}
Short-Circuit Current Limit	ILIM	V _{OUT} = 0V		700	1400	2300	mA
SET Dual Mode [™] Threshold				35	80	125	mV
SET Input Bias Current	ISET	$V_{SET} = +0.8V$		-100		+100	nA
Ground-Pin Current		I _{OUT} = 1mA			210	400	
Ground-Pin Current	lq	$I_{OUT} = 500 \text{mA}$			575		μA
		I _{OUT} = 500mA	$V_{OUT} = +2.25V$		259	384	
Dropout Voltage (Note 1)			$V_{OUT} = +2.8V$		201	315	mV
			$V_{OUT} = +4.0V$		147	255	
Line Regulation	ΔV_{LNR}	V_{IN} from (V_{OUT} + 1	00mV) to 5.5V, $I_{LOAD} = 5mA$		0	0.125	%/V
Load Regulation	ΔV_{LDR}	I _{OUT} = 1mA to 500	mA		15.5	35	ppm/mA
Output Voltage Noise		10Hz to 1MHz, C _O	$_{\rm UT}$ = 10µF (ESR < 0.1 Ω)		300		μV _{RMS}
SHUTDOWN							
Shutdown Supply Current	IOFF	$\overline{\text{SHDN}} = \text{GND}, \text{V}_{\text{IN}}$	= 5.5V		0.02	5	μΑ
SHDN Input Threshold	VIH	н		1.6			V
	VIL					0.6	v
SHDN Input Bias Current	ISHDN	SHDN = GND or IN			10	100	nA
Startup Time	TSTART	$C_{OUT} = 10\mu$ F, time from SHDN high to POK high			40		μs

Dual Mode is a trademark of Maxim Integrated Products, Inc.

M/IXI/M

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{IN} = V_{OUT(SETPOINT)} + 500mV \text{ or } V_{IN} = +2.25V \text{ whichever is greater, SET} = GND, \overline{SHDN} = IN, T_A = 0°C to +85°C, unless otherwise noted. Typical values are at T_A = +25°C.)$

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
POWER-OK						
POK Output Low Voltage	Vol	Sinking 2mA		5	50	mV
Operating Voltage Range for Valid POK Output		Sinking 100µA			5.5	V
Output High-Leakage Current		V _{POK} = +5.5V			100	nA
Threshold		Rising edge, referred to VOUT(NOMINAL)	90	93	96	%
THERMAL PROTECTION						
Thermal Shutdown Temperature	TSHDN			170		°C
Thermal Shutdown Hysteresis	ΔT_{SHDN}	20			°C	

ELECTRICAL CHARACTERISTICS

 $(V_{IN} = V_{OUT(SETPOINT)} + 500mV \text{ or } V_{IN} = +2.25V \text{ whichever is greater, SET} = GND, \overline{SHDN} = IN, T_A = -40^{\circ}C \text{ to } +85^{\circ}C$, unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$.) (Note 2)

PARAMETER	SYMBOL	С	CONDITIONS		ТҮР	MAX	UNITS
Input Voltage	VIN			2.25		5.5	V
Input Undervoltage Lockout	VUVLO	Rising, 40mV hyst	eresis	1.85		2.15	V
Output Voltage Accuracy (Preset Mode)	Vout	$I_{OUT} = 1$ mA to 50	OmA	-4		+4	%
Adjustable Output Voltage				0.8		4.5	V
SET Voltage Threshold (Adjustable Mode)	VSET	$I_{OUT} = 1$ mA to 50	OmA	766		834	mV
Maximum Output Current	IOUT			500			mA _{RMS}
Short-Circuit Current Limit	ILIM	$V_{OUT} = 0V$		700		2500	mA
SET Dual Mode [™] Threshold				35		125	mV
SET Input Bias Current	ISET	$V_{\text{SET}} = +0.8V$		-100		+100	nA
Ground-Pin Current	IQ	$I_{OUT} = 1mA$				400	μΑ
			$V_{OUT} = +2.25V$		259	384	
Dropout Voltage (Note 1)		I _{OUT} = 500mA	$V_{OUT} = +2.8V$		201	315	mV
			$V_{OUT} = +4.0V$		147	255	
Line Regulation	ΔV_{LNR}	VIN from (VOUT +	100mV) to 5.5V, I _{LOAD} = 5mA	-0.175		+0.175	%/V
Load Regulation	ΔV_{LDR}	$I_{OUT} = 1 mA$ to 50	0mA			35	ppm/mA
SHUTDOWN							
Shutdown Supply Current	IOFF	$\overline{\text{SHDN}} = \text{GND}, V_{\text{IN}} = 5.5 \text{V}$				5	μΑ
SHDN Input Threshold	VIH	$2.5V < V_{IN} < 5.5V$ $2.5V < V_{IN} < 5.5V$		1.6			V
Show input mreshold	VIL					0.6	v
SHDN Input Bias Current	ISHDN	SHDN = GND or IN				100	nA

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{IN} = V_{OUT(SETPOINT)} + 500mV \text{ or } V_{IN} = +2.25V \text{ whichever is greater, SET} = GND, \overline{SHDN} = IN, T_A = -40^{\circ}C \text{ to } +85^{\circ}C$, unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
POWER-OK						
POK Output Low Voltage	VOL	Sinking 2mA			50	mV
Operating Voltage Range for Valid POK Output		Sinking 100µA	1.0		5.5	V
Output High-Leakage Current		V _{POK} = +5.5V			100	nA
Threshold		Rising edge, referred to $V_{OUT(NOMINAL)}$	89		97	%

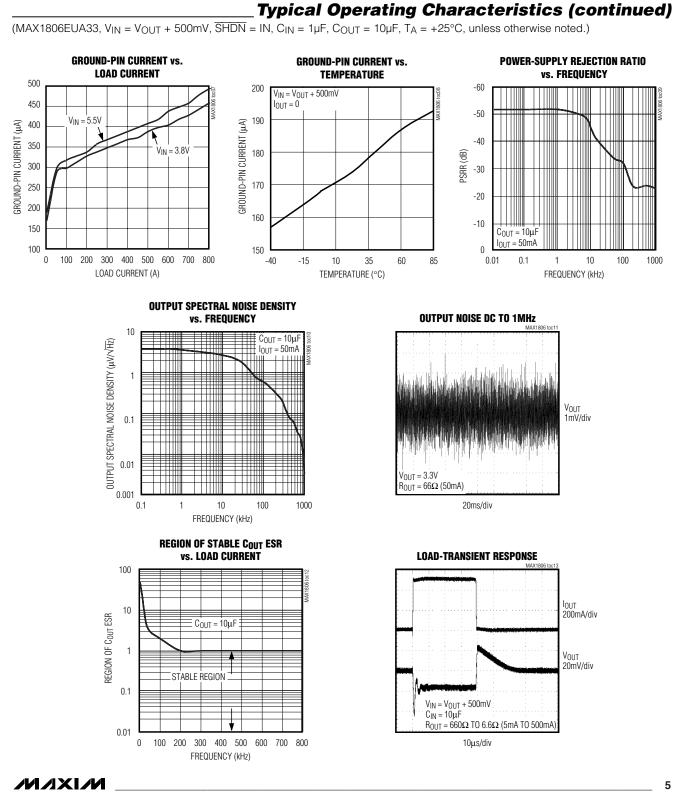
Note 1: Dropout voltage is defined as $V_{IN} - V_{OUT}$, when V_{OUT} is 100mV below the value of V_{OUT} and when $V_{IN} = V_{OUT(NOM)} + 0.5V$. For 2.25V $\leq V_{OUT} \leq 4.0V$, dropout voltage limits are linearly interpolated from the values listed. For $V_{OUT} < 4.0V$, dropout voltage limit is equal to the value for $V_{OUT} = 4.0V$.

(MAX1806EUA33, VIN = VOUT + 500mV, SHDN = IN, CIN = 1µF, COUT = 10µF, TA = +25°C, unless otherwise noted.)

Typical Operating Characteristics

Note 2: Specifications to -40°C are guaranteed by design, not production tested.

OUTPUT VOLTAGE vs. INPUT VOLTAGE OUTPUT VOLTAGE vs. LOAD CURRENT OUTPUT VOLTAGE vs. TEMPERATURE 3.5 3.32 3.34 $V_{IN} = V_{OUT} + 500 \text{mV}$ $I_{OUT} = 0 m A$ $I_{OUT} = 0$ 3.0 3.31 3.33 () 3.30 3.29 3.28 3.28 3.27 OUTPUT VOLTAGE (V) 2.5 $I_{OUT} = 500 \text{mA}$ 3.32 **OUTPUT VOLTAGE** 2.0 3.31 1.5 3.30 1.0 3.27 3.29 0.5 3.26 0 3.25 3.28 1.5 2.0 2.5 3.0 3.5 4.0 4.5 5.0 5.5 6.0 100 200 300 400 500 600 700 800 0 -40 -15 10 35 60 85 INPUT VOLTAGE (V) LOAD CURRENT (mA) TEMPERATURE (°C) **DROPOUT VOLTAGE vs. GROUND-PIN CURRENT vs. INPUT VOLTAGE OUTPUT VOLTAGE DROPOUT VOLTAGE vs. LOAD CURRENT** 400 600 550 350 0.28 500 IOUT = 500mA GROUND-PIN CURRENT (µA) $T_A = +85^{\circ}C$ 300 450 0.26 DROPOUT VOLTAGE (mV) DROPOUT VOLTAGE (V) 400 250 0.24 350 . T_A = +25°C 300 200 0.22 $I_{OUT} = 0 m A$ 250 150 0.20 200 150 100 0.18 -40°C 100 50 0.16 50 0 0 0.14 2.5 3.0 3.5 4.0 4.5 0 100 200 300 400 500 600 700 800 2.0 2.5 3.0 3.5 40 4.5 2.0 5.0 5.5 60 INPUT VOLTAGE (V) OUTPUT VOLTAGE (V) LOAD CURRENT (mA) ///XI// 4



Typical Operating Characteristics (continued) (MAX1806EUA33, VIN = VOUT + 500mV, SHDN = IN, CIN = 1µF, COUT = 10µF, TA = +25°C, unless otherwise noted.) LOAD-TRANSIENT RESPONSE NEAR DROPOUT LINE-TRANSIENT RESPONSE MAX1806 toc14 06 toc15 6V V_{IN} 1V/div I_{OUT} 200mA/div 3V V_{OUT} 50mV/div $V_{IN} = V_{OUT} + 100mV$ V_{OUT} 10mV/div $C_{IN} = 10 \mu F$ $R_{OUT} = 660 \Omega TO$ 6.6Ω (5mA TO 500mA) 10µs/div 200µs/div SHUTDOWN WAVEFORM **POK WAVEFORM** MAX1806 toc17 5V 2V V_{IN} 2V/div V_{SHDN} 1V/div 0 0 VOUT 3V 2V/div 0 VOUT 1V/div V_{POK} 2V/div 0 0 $R_{OUT} = 66\Omega$ (50mA) $R_{OUT} = 6.6\Omega$ (500mA)

200µs/div

Pin Description

PIN	NAME	FUNCTION
1, 2	IN	Regulator Input. Supply voltage can range from +2.25V to +5.5V. Bypass with a 1μ F capacitor to GND (see <i>Capacitor Selection and Regulation Stability</i>). Connect both input pins together externally.
3	POK	Open-Drain, Active-Low Power-OK Output. POK remains low while the output voltage (V _{OUT}) is below the POK threshold. Connect a 100k Ω pullup resistor from POK to OUT.
4	SHDN	Active-Low Shutdown Input. A logic low at \overline{SHDN} reduces supply current to 0.02µA. In shutdown, the POK output is low. Connect \overline{SHDN} to IN for normal operation.
5	GND	Ground. This pin and the exposed pad also function as a heatsink. Solder both to a large pad or to the circuit-board ground plane to maximize power dissipation.
6	SET	Voltage-Setting Input. Connect SET to GND for preset output. Connect an external resistive voltage-divider from OUT to SET to set the output voltage between 0.8V and 4.5V. The SET regulation voltage is 800mV.
7, 8	OUT	Regulator Output. OUT sources up to 500mA. Bypass OUT with a 10μ F low-ESR capacitor to GND. Connect both OUT pins together externally.

20µs/div

Downloaded from Elcodis.com electronic components distributor

6

Detailed Description

The MAX1806 is a low-dropout, low-quiescent-current linear regulator. The device supplies loads up to 500mA and is available with preset output voltages. As illustrated in Figure 1, the MAX1806 includes a 0.8V reference, error amplifier, P-channel pass transistor, and internal feedback voltage-divider.

The reference is connected to the error amplifier, which compares it with the feedback voltage and amplifies the difference. If the feedback voltage is lower than the reference voltage, the pass-transistor gate is pulled lower, which allows more current to pass to the output increasing the output voltage. If the feedback voltage is too high, the pass-transistor gate is pulled up, allowing less current to pass to the output.

The output voltage is fed back through either an internal resistive voltage-divider connected to OUT or an external resistor network connected to SET. The dualmode comparator examines V_{SET} and selects the feedback path. If V_{SET} is below 35mV, the internal feedback path is used, and the output is regulated to the factorypreset voltage. Additional blocks include an output current limiter, thermal sensor, and shutdown logic.

Internal P-Channel Pass Transistor

The MAX1806 features a 0.4 Ω P-channel MOSFET pass transistor. Unlike similar designs using PNP pass transistors, P-channel MOSFETs require no base drive, which reduces operating current. PNP-based regulators also waste considerable current in dropout when the pass transistor saturates, and use high base-drive currents under large loads. The MAX1806 does not suffer from these problems.

Output Voltage Selection

The MAX1806's dual-mode operation allows operation in either a preset voltage mode or an adjustable mode. Connect SET to GND to select the preset output voltage. The two-digit part number suffix identifies the output voltage (see *Selector Guide*). For example, the MAX1806EUA33 has a preset 3.3V output voltage. The output voltage may also be adjusted by connecting a voltage-divider from OUT to SET (Figure 2). Select R2 in the 25k Ω to 100k Ω range. Calculate R1 with the following equation:

R1 = R2 [(VOUT / VSET) - 1]

where V_{SET} = 0.8V, and V_{OUT} may range from 0.8V to 4.5V.

Shutdown

Drive SHDN low to enter shutdown. During shutdown, the output is disconnected from the input, and supply

M/X/M

current drops to 0.02μ A. When in shutdown, POK pulls low. The capacitance and load at OUT determine the rate at which V_{OUT} decays. SHDN can be pulled as high as +6V, regardless of the input and output voltage.

Power-OK Output

The POK output pulls low when OUT is less than 93% of the nominal regulation voltage. Once OUT exceeds 93% of the nominal voltage, POK goes high impedance. POK is an open-drain N-channel output. To obtain a logic voltage output, connect a pullup resistor from POK to OUT. A 100k Ω resistor works well for most applications. POK can be used to signal a microcontroller (μ C), or drive an external LED to indicate power failure. When the MAX1806 is shutdown, POK is held low independent of the output voltage. If unused, leave POK grounded or unconnected.

Current Limit

The MAX1806 monitors and controls the pass transistor's gate voltage, limiting the output current to 1.4A (typ). The output can be shorted to ground for an indefinite period of time without damaging the part.

Thermal Overload Protection

Thermal overload protection limits total power dissipation in the MAX1806. When the junction temperature exceeds $T_J = +170^{\circ}C$, a thermal sensor turns off the pass transistor, allowing the device to cool. The thermal sensor turns the pass transistor on again after the junction temperature cools by 20°C, resulting in a pulsed output during continuous thermal overload conditions. Thermal overload protection protects the MAX1806 in the event of fault conditions. For continuous operation, do not exceed the absolute maximum junction-temperature rating of $T_J = +150^{\circ}C$.

Operating Region and Power Dissipation The MAX1806's maximum power dissipation depends on the thermal resistance of the IC package and circuit board, the temperature difference between the die junction and ambient air, and the rate of air flow. The power dissipated in the device is $P = I_{OUT} \times (V_{IN} - V_{OUT})$. The maximum allowed power dissipation is 1.3W or:

$$PMAX = (T_{J(MAX)} - T_A) / (\theta_{JC} + \theta_{CA})$$

where $T_J - T_A$ is the temperature difference between the MAX1806 die junction and the surrounding air, θ_{JC} is the thermal resistance from the junction to the case, and θ_{CA} is the thermal resistance from the case through the PC board, copper traces, and other materials to the surrounding air. The MAX1806 package features an exposed thermal pad on its underside. This pad lowers the package's thermal resistance by provid-



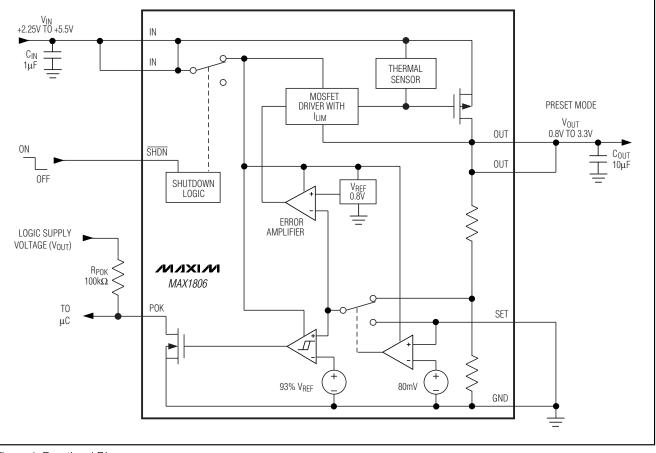


Figure 1. Functional Diagram

ing a direct heat conduction path from the die to the PC board. Connect the exposed backside pad and GND to the system ground using a large pad or ground plane, or multiple vias to the ground plane layer.

The MAX1806 delivers up to 0.5A(RMS) and operates with input voltages up to 5.5V, but not simultaneously. High output currents can only be sustained when input-output differential is within the limits outlined.

Applications Information

Capacitor Selection and Regulator Stability

Connect a 1μ F capacitor between IN and ground and a 10μ F low equivalent series resistance (ESR) capacitor between OUT and ground. The input capacitor (C_{IN}) lowers the source impedance of the input supply. Reduce noise and improve load-transient response, stability, and power-supply rejection by using larger

output capacitors. The output capacitor's (C_{OUT}) ESR affects stability and output noise. Use output capacitors with an ESR of 0.1 Ω or less to ensure stability and optimum transient response. Surface-mount ceramic capacitors have very low ESR and are commonly available in values up to 10µF. Connect C_{IN} and C_{OUT} as close to the MAX1806 as possible.

Noise, PSRR, and Transient Response The MAX1806 is designed to operate with low dropout voltages and low quiescent currents, while still maintaining good noise, transient response, and AC rejection. See the *Typical Operating Characteristics* for a plot of Power-Supply Rejection Ratio (PSRR) vs. Frequency. When operating from noisy sources, improved supply-noise rejection and transient response can be achieved by increasing the values of the input and output bypass capacitors and through passivefiltering techniques. The MAX1806 load-transient

8

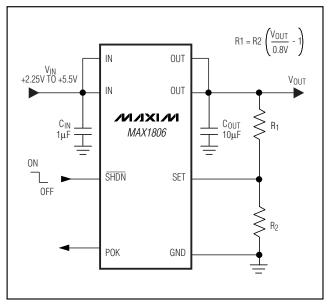


Figure 2. Adjustable Output Using External Feedback Resistors

response graphs (see *Typical Operating Characteristics*) show two components of the output response: a DC shift from the output impedance due to the load current change, and the transient response. A typical transient overshoot for a step change in the load current from 5mA to 500mA is 40mV. Increasing the output capacitor's value and decreasing the ESR attenuates the overshoot.

Input-Output (Dropout) Voltage

A regulator's minimum input-to-output voltage differential (dropout voltage) determines the lowest usable supply voltage. In battery-powered systems, this determines the useful end-of-life battery voltage. Because the MAX1806 uses a P-channel MOSFET pass transistor, its dropout voltage is a function of drain-tosource on-resistance (R_{DS(ON)}) multiplied by the load current (see *Typical Operating Characteristics*):

VDROPOUT = VIN - VOUT = RDS(ON) × IOUT

Chip Information

TRANSISTOR COUNT: 949

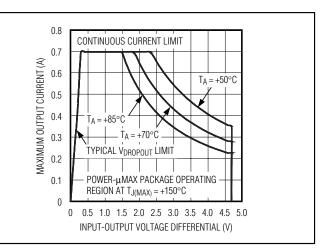
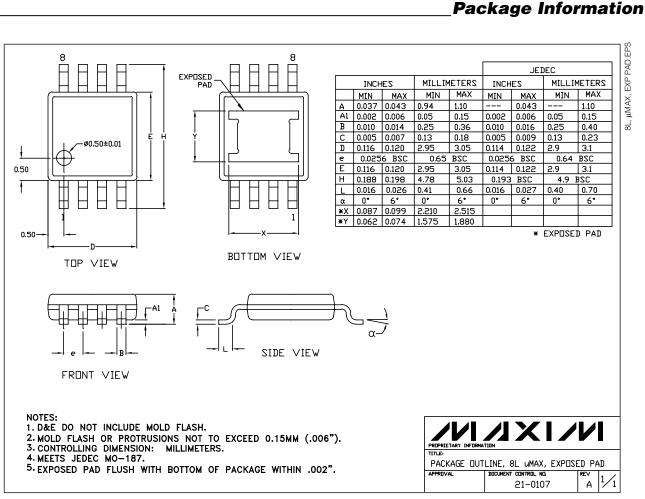


Figure 3. Power Operating Regions: Maximum Output Current vs. Supply Voltage



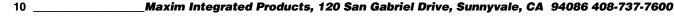
MAX1806





Note: The MAX1806 has on exposed thermal pad on the bottom side of the package.

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.



© 2001 Maxim Integrated Products

s Printed USA

is a registered trademark of Maxim Integrated Products.